

# 2MBI200N-060-03

IGBT Module

## 600V / 200A 2 in one-package

### ■ Features

- VCE(sat) classified for easy parallel connection
- High speed switching
- Voltage drive
- Low inductance module structure

### ■ Applications

- Inverter for Motor drive
- AC and DC Servo drive amplifier
- Uninterruptible power supply
- Industrial machines, such as Welding machines

### ■ Maximum ratings and characteristics

#### ● Absolute maximum ratings (at Tc=25°C unless otherwise specified)

Item	Symbol	Rating	Unit
Collector-Emitter voltage	V <sub>CES</sub>	600	V
Gate-Emitter voltage	V <sub>GES</sub>	±20	V
Collector current	Continuous	I <sub>C</sub>	200
	1ms	I <sub>C</sub> pulse	400
		-I <sub>C</sub>	200
	1ms	-I <sub>C</sub> pulse	400
Max. power dissipation	P <sub>C</sub>	780	W
Operating temperature	T <sub>j</sub>	+150	°C
Storage temperature	T <sub>stg</sub>	-40 to +125	°C
Isolation voltage	V <sub>is</sub>	AC 2500 (1min.)	V
Screw torque	Mounting *1	3.5	N·m
	Terminals *1	3.5	N·m

\*1 : Recommendable value : 2.5 to 3.5 N·m(M5)

#### ● Electrical characteristics (at T<sub>j</sub>=25°C unless otherwise specified)

Item	Symbol	Characteristics			Conditions	Unit
		Min.	Typ.	Max.		
Zero gate voltage collector current	I <sub>CES</sub>	—	—	2.0	V <sub>GE</sub> =0V, V <sub>CE</sub> =600V	mA
Gate-Emitter leakage current	I <sub>GES</sub>	—	—	30	V <sub>CE</sub> =0V, V <sub>GE</sub> =±20V	μA
Gate-Emitter threshold voltage	V <sub>GE(th)</sub>	4.5	—	7.5	V <sub>CE</sub> =20V, I <sub>C</sub> =200mA	V
Collector-Emitter saturation voltage	V <sub>CE(sat)</sub>	—	—	2.8	V <sub>GE</sub> =15V, I <sub>C</sub> =200A	V
Input capacitance	C <sub>ies</sub>	—	13200	—	V <sub>GE</sub> =0V	pF
Output capacitance	C <sub>oes</sub>	—	2930	—	V <sub>CE</sub> =10V	
Reverse transfer capacitance	C <sub>res</sub>	—	1330	—	f=1MHz	
Turn-on time	t <sub>on</sub>	—	0.6	1.2	V <sub>CC</sub> =300V	μs
	t <sub>r</sub>	—	0.2	0.6	I <sub>C</sub> =200A	
Turn-off time	t <sub>off</sub>	—	0.6	1.0	V <sub>GE</sub> =±15V	μs
	t <sub>f</sub>	—	0.2	0.35	R <sub>G</sub> =9.1ohm	
Diode forward on voltage	V <sub>F</sub>	—	—	3.0	I <sub>F</sub> =200A, V <sub>GE</sub> =0V	V
Reverse recovery time	t <sub>rr</sub>	—	—	0.3	I <sub>F</sub> =200A	μs

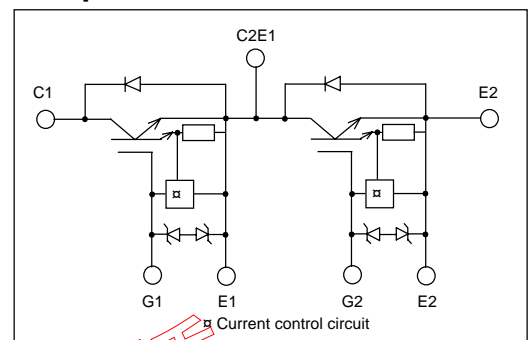
#### ● Thermal resistance characteristics

Item	Symbol	Characteristics			Conditions	Unit
		Min.	Typ.	Max.		
Thermal resistance	R <sub>th(j-c)</sub>	—	—	0.16	IGBT	°C/W
	R <sub>th(j-c)</sub>	—	—	0.35	Diode	°C/W
	R <sub>th(c-f)*2</sub>	—	0.025	—	the base to cooling fin	°C/W

\*2 : This is the value which is defined mounting on the additional cooling fin with thermal compound



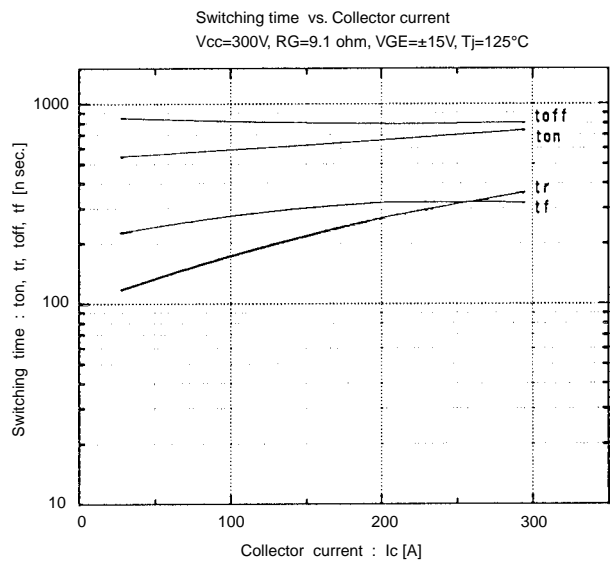
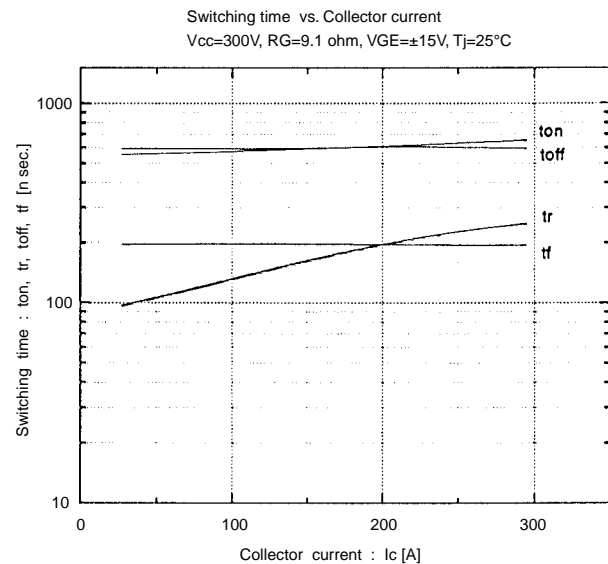
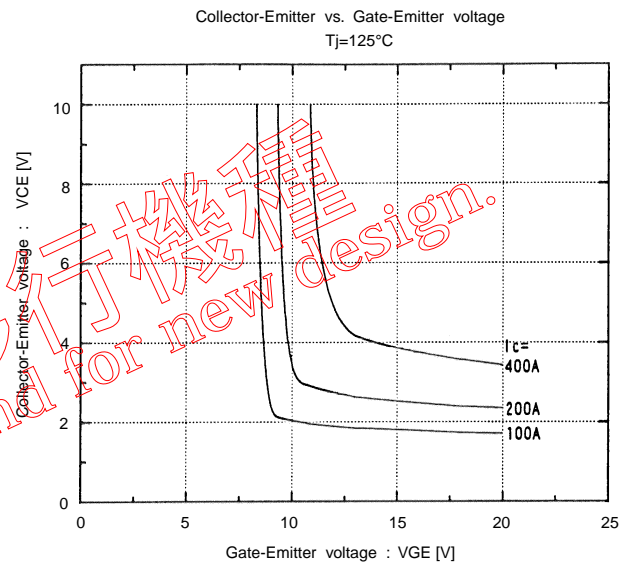
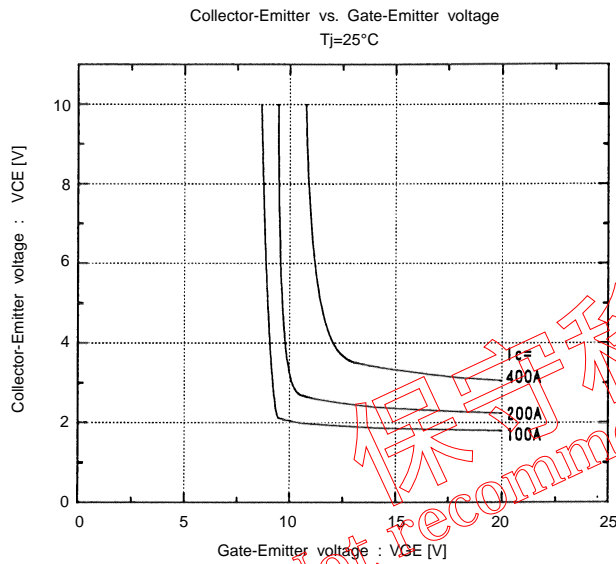
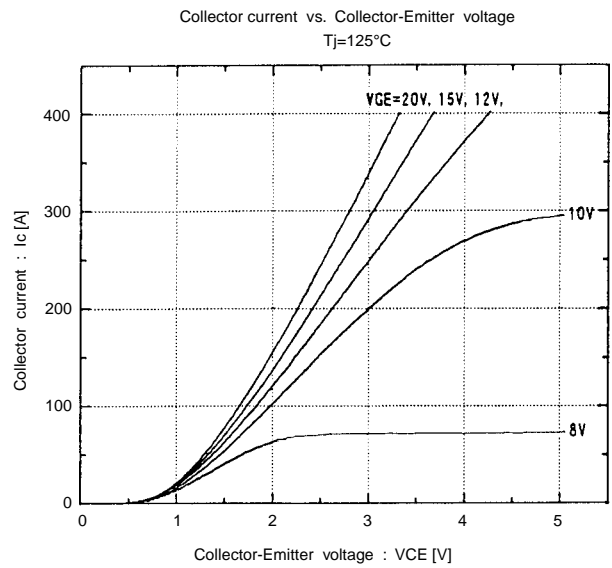
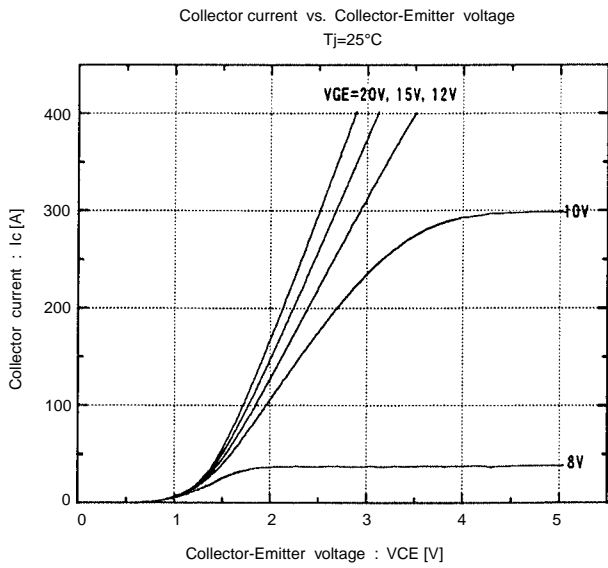
### ■ Equivalent Circuit Schematic



#### ● VCE(sat) classification

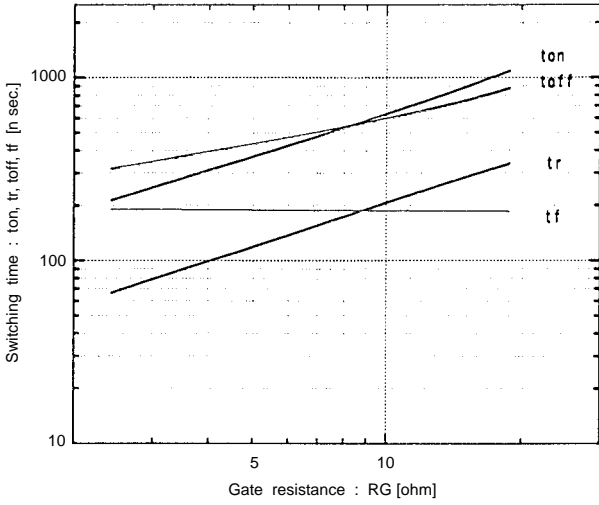
Rank	V <sub>CE(sat)</sub>	Conditions
F	1.85 to 2.10V	I <sub>C</sub> = 200A V <sub>GE</sub> = 15V T <sub>j</sub> = 25°C
A	2.00 to 2.25V	
B	2.15 to 2.40V	
C	2.30 to 2.60V	
D	2.50 to 2.80V	

Characteristics (Representative)

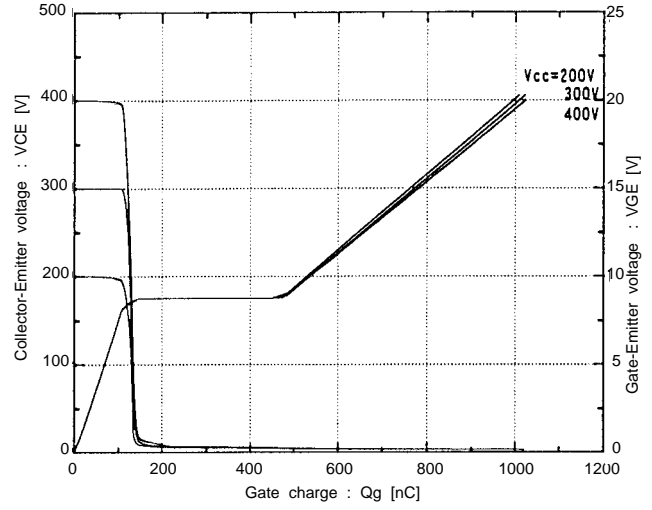


保存移行機種  
 Not recommend for new design.

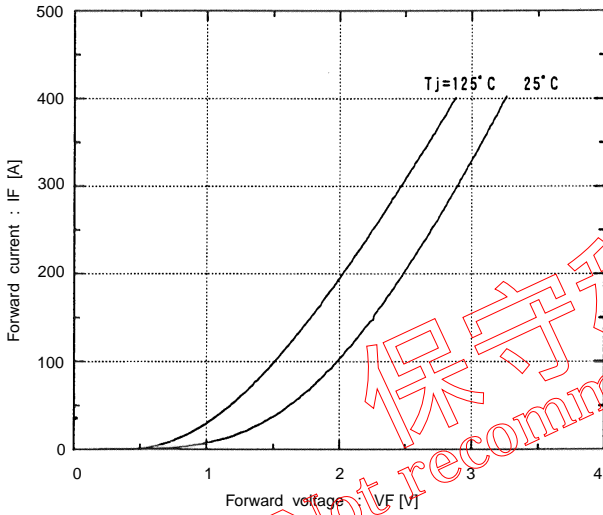
Switching time vs. RG  
Vcc=300V, Ic=200A, VGE=±15V, Tj=25°C



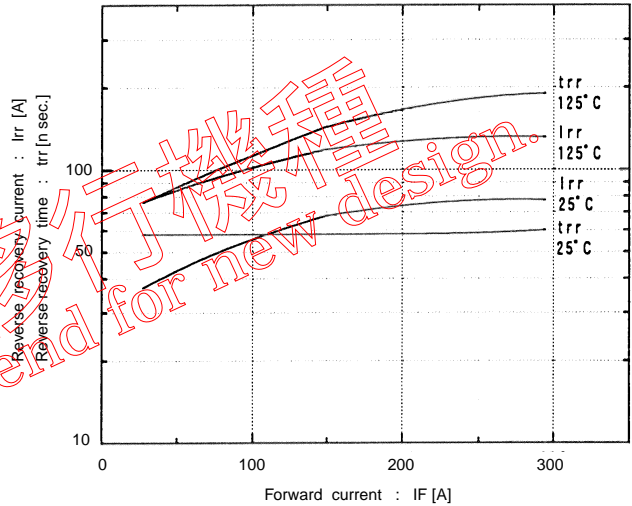
Dynamic input characteristics  
Tj=25°C



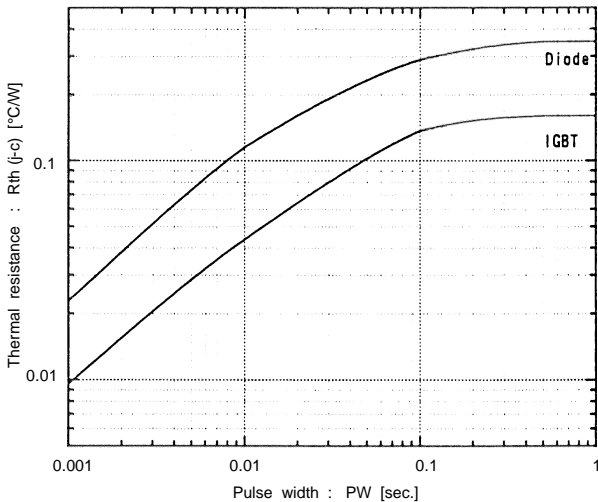
Forward current vs. Forward voltage  
VGE=0V



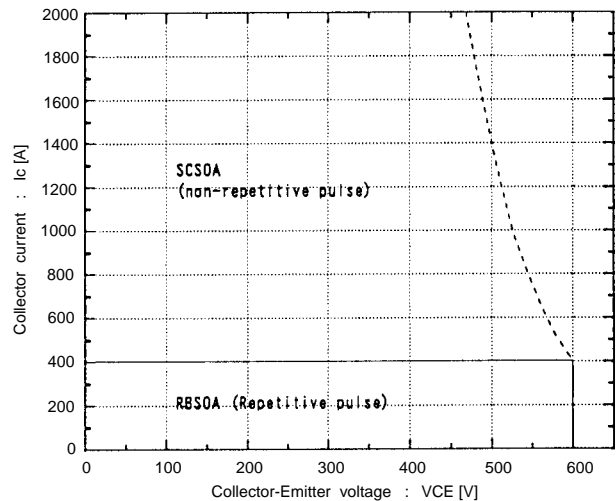
Reverse recovery characteristics  
trr, Irr, vs. IF



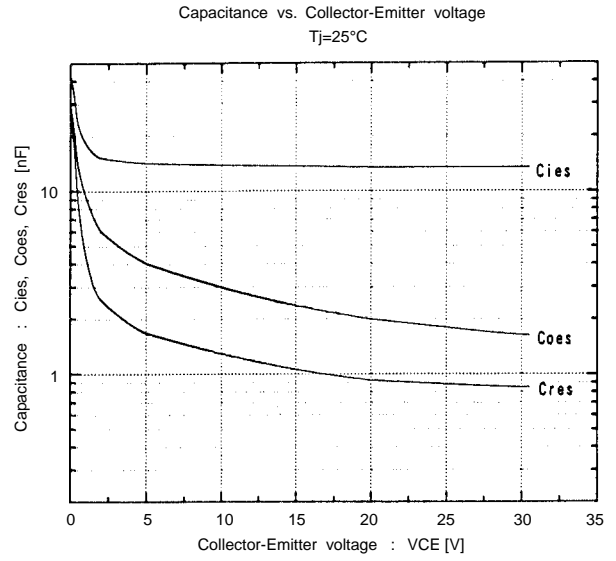
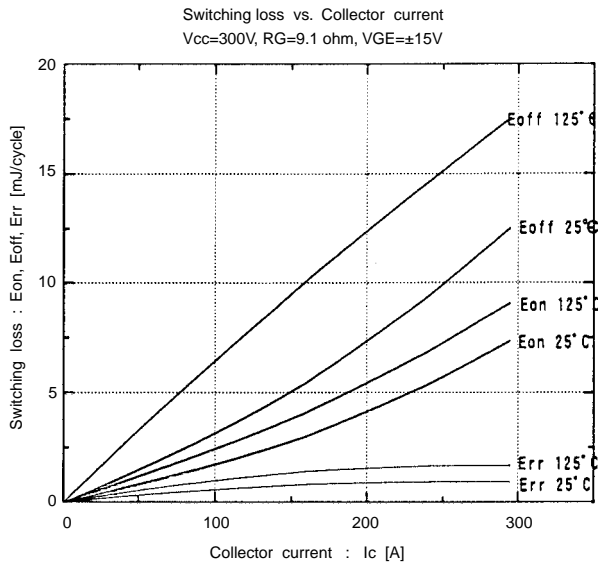
Transient thermal resistance



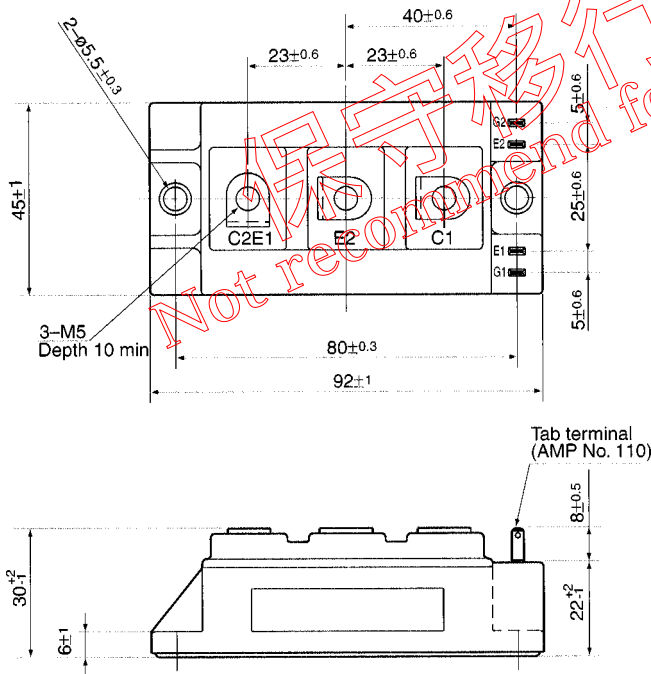
Reversed biased safe operating area  
+VGE=15V, -VGE ≤ 15V, Tj ≤ 125°C, RG ≥ 9.1 ohm



保守發行機種  
 Not recommend for new design.



■ Outline Drawings, mm



Mass : 240g

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